

Docket Number: 1601457-0007

## **DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.									
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled									
the specification of v	which is attached h	nereto unless the following b	ox is checked:						
	X was filed on July 3, 2001 as United States Application Number 09/898,365 or International Application Number and was amended on (if applicable).								
		understand the contents of the mended by any amendment							
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.									
application(s) for pate application which des have also identified b	ent or inventor's cosignated at least or elow, by checking PCT international	ertificate, or § 365(a) of any ne country other than the Ung the box, any foreign applic application having a filing of	nited States, listed below and ation for patent or inventor's						
Prior Foreign Applica	ation(s)		Priority Is Claimed						
PCT/SG01/00134	Singapore	28 /6 /2001	X						
Number	Country	Day/Month/Year Filed	<u> </u>						
Number	Country	Day/Month/Year Filed							
I hereby claim the beau application(s) listed b		S.C. § 119(e) of any United S	States provisional						
(Application Number	)		(Filing Date)						
I hereby claim the be	enefit under 35 U.S	S.C. § 120 of any United Sta	ates application(s), or § 365(c						

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in

 $37\ CFR\ \S\ 1.56$  which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Number)	(Filing Date)	(Status-	-patented, pe	ending, aba	andoned)
(Application Number)	(Filin	g Date)	(Status <sub>1</sub>	patented, p	pending, abandoned)
I/we hereby appoint <b>Pract</b> agent(s) to prosecute the a States Patent and Tradema	application identifi	ied above,	and to transa	•	
Address all correspondence				Facsimile	No.: 212-354-8113
I hereby declare that all statements made on information were made with the know fine or imprisonment, or bouch willful false statement thereon.	nation and belief a ledge that willful to oth, under Section	are believe false staten n 1001 of	to be true; ar nents and the Fitle 18 of th	nd further to like so made United S	that these statements ade are punishable by states Code and that
Full name of sole or first in	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	e, middle i	nitial, last na	•	ng Pin Poo 30 - 7 - 2001
Residence: <u>Apt Blk 44, Be</u> Citizenship: <u>Malaysian, S</u>				<u>50044, Sin</u>	<u>igapore</u>
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X Additional inventor	rs are named on th	ne page(s)	attached here	eto.	

Full name of second inventor (first name, middle initial, last name): Lay Chuan Lim								
Second inventor's signatu	`	198.	Date:	30/07/2001				
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